

2 mil Polyimide Tape 2B - Series

GENERAL DESCRIPTION

This tape consisting of a polyimide film and silicone adhesive designed for high temperature masking applications.

APPLICATIONS

- Mask for protection of gold fingers of printed circuit board during wave solder or solder dip process
- Release surface in fabrication of parts cured at elevated temperatures.
- Widely used for electrical insulation on transformers, motor, coils, PCB making and so on

PRODUCT BENEFITS

- Thin and conformable enabling masking of uneven surfaces
- Wide operating temperature range up to 500°F
- Excellent electrical insulation
- Removes cleanly without adhesive residue after exposure to heat/chemical
- Meets UL-94V0

TECHNICAL PROPERTIES

Total Thickness Adhesive Thickness (silicone) Film Thickness (polyimide) Adhesive Color

2.0 mil Amber

3.5 mils

1.5 mils

ADHESIVE TEST DATA

Adhesion to Steel Break Strength Dielectric Strength Elongation Operating Temperature Range 25 oz/inch 50 lbs/in 11000 volts 60% -40°F to 500°F

NOTE:

- 1. When applying pressure sensitive adhesive films to any surface, be sure that the surface is free from oil or other surface contaminates such as powder, dust, or release agents. Adhesive performance should be carefully checked when used on substrates containing plasticizers.
- Shelf life is one year from date of shipment when stored in a cool dry place below 76° F (24°C). Rolls should be stored on end.
 The above values are "Typical Values" which have a nominal range shout the stored of the stored on end.
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